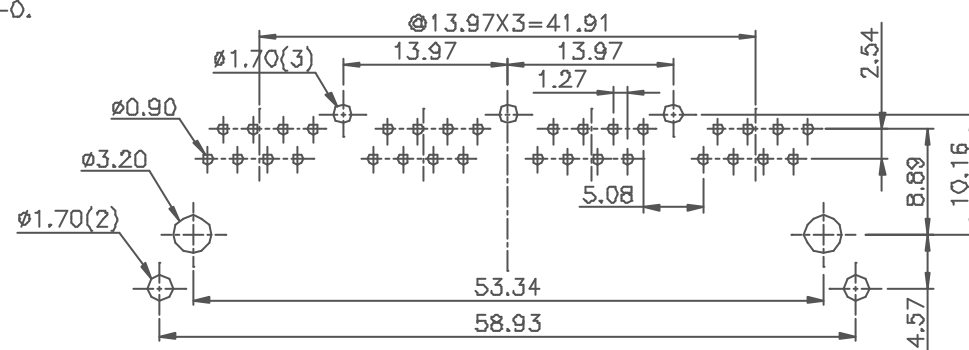
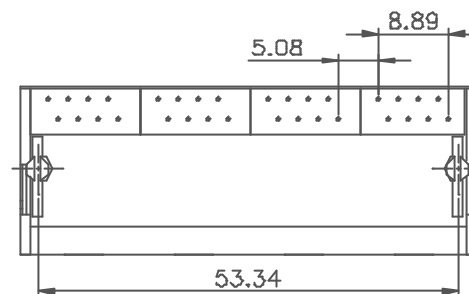
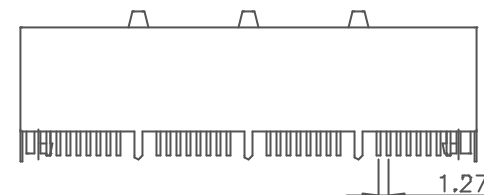
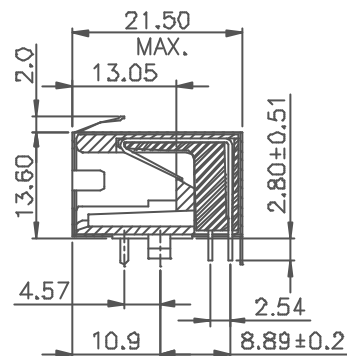
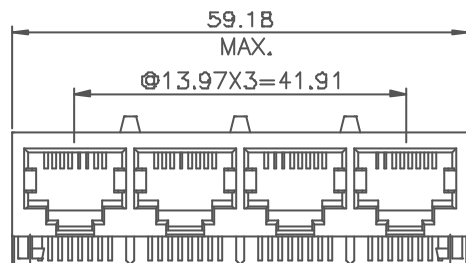




PC Board Layout Component Side Shown

NOTES:

ELECTRICAL:

1. VOLTAGE RATING : 125 VAC RMS MIN.
2. CURRENT RATING : 1.5 AMP MIN.
3. CONTACT RESISTANCE : 35 MINIOHMS MAX.
4. INSULATION RESISTANCE: 500 MEGOHMS MIN @ 500 VDC.
5. DIELECTRIC STRENGTH : 1000 VAC RMS 60Hz, 1MIN.

MECHANICAL:

1. HOUSING MATERIAL : GLASS FILLED POLYESTER UL94V-0.
2. CONTACT MATERIAL : PHOSPHOR BRONZE Ø0.46mm.
3. PLATING : GOLD PLATING OVER NICKEL.
4. OPERATING LIFE : 250 CYCLES MIN.
5. PCB RETENTION PRE-SOLDER : 1 LB MIN.
6. PCB RETENTION POST-SOLDER: 10 LBS MIN.

ENVIRONMENTAL:

1. STORAGE : -40°C TO +85°C.
2. OPERATION: 0°C TO 70°C.

MATES WITH MODULAR PLUG CONFORMING TO
FCC PART 68, SUBPART F.

CUL FILE NO. E163191

PART NUMBER: E5988-2XCXCX

3-單層,鍍金接觸面
5-單層,鍍金接觸面
1-3u" 2-6u" 3-15u"
4-30u" 5-50u" 6-Pd20u"
1-單面4.57
2-單面4.57,鍍1次金
3-單面4.57,鍍3次金

REVISION RECORD				
REV	ECO	DESCRIPTION	DFT	CHKD
1		圖面修正	BASS	
			2/17/98	

DETAILS	MM (INCH)		DFTD: BASS	DATE: 10/30/97
	TOLERANCES EXCEPT AS NOTED		CHKD:	DATE:
	NM		MFO:	DATE:
	APPL:		DATE:	
ANGLES ± 0.5		MATERIAL:		
THIRD ANGLE PROJECTION		QTY:		
		FINISH:		
		SCALE: 1.5 : 1		

FULL RISE ELECTRONIC CO., LTD

TITLE

20.57 PCB JACK 8P 加深型

DRAWING NO. 5-0179-4
/PART NO. SEE NOTE

SIZE A3
REV 2/17/98

DO NOT SCALE DRAWING

SHEET OF